

## PATENT ASSIGNMENT COVER SHEET

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<b>DATE SIGNED:</b>	10/07/2016	
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Invention Title: High Density Self Digitization Chip

Inventor(s): Thomas Schneider, Jason E Kreutz, Daniel T Chiu

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Patent or Application Serial No.: 14/900,926

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Foreign Applications filed/intended in (countries): CHINA, EUR PATENT OFC, JAPAN

The invention identified above is a Subject Invention under **35 U.S.C. 200, et seq.**, and the Standard Patent Rights clause at **37 CFR 401.14, FAR 52.227-11** or **FAR 52.227-12** (if applicable) which are included among the terms of the above identified grant or contract award from the United States Government. This document is confirmatory of:

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Signed this 23rd day of September, 20 16

By Jesse S. Kindra  
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For UNIVERSITY OF WASHINGTON  
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